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Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Not For New Designs
Core Processor	STM8A
Core Size	8-Bit
Speed	24MHz
Connectivity	CANbus, I ² C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	68
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	2K x 8
RAM Size	6K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 16x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 150°C (TA)
Mounting Type	Surface Mount
Package / Case	80-LQFP
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/stmicroelectronics/stm8af52aatdy

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3 Product line-up

Table 2. STM8AF526x/8x/Ax product line-up with CAN

Order code	Package	High density Flash program memory (bytes)	RAM (bytes)	Data EEPROM (bytes)	10-bit A/D chan.	Timers (IC/OC/PWM)	Serial interfaces	I/O wakeup pins
STM8AF/P52AA	LQFP80 (14x14)	128 K	6 K	2 K	16	1x8-bit: TIM4 3x16-bit: TIM1, TIM2, TIM3 (9/9/9)	CAN, LIN(UART), SPI, USART, I ² C	68/37
STM8AF/P528A		64 K						
STM8AF/P52A9	128 K	52/36						
STM8AF/P5289	64 K							
STM8AF/P5269	32 K			1 K				
STM8AF/P52A8	LQFP48 (7x7)	128 K		2 K	10			38/35
STM8AF/P5288		64 K						
STM8AF/P5268		32 K						
STM8AF/P5286	VFQFPN32 (5x5)	64 K		2 K	6	1x8-bit: TIM4 3x16-bit: TIM1, TIM2, TIM3 (8/8/8)	CAN, LIN(UART), I ² C	25/24
STM8AF/P52A6		128 K						

Table 3. STM8AF6269/8x/Ax product line-up without CAN

Order code	Package	High density Flash program memory (bytes)	RAM (bytes)	Data EEPROM (bytes)	10-bit A/D chan.	Timers (IC/OC/PWM)	Serial interfaces	I/O wakeup pins
STM8AF/P62AA	LQFP80 (14x14)	128 K	6 K	2 K	16	1x8-bit: TIM4 3x16-bit: TIM1, TIM2, TIM3 (9/9/9)	LIN(UART), SPI, USART, I ² C	68/37
STM8AF/P628A		64 K						
STM8AF/P62A9	128 K	2 K						
STM8AF/P6289	64 K							
STM8AF/P6269	32 K			1 K				
STM8AF/P62A8	LQFP48 (7x7)	128 K		2 K	10			25/23
STM8AF/P6288								
STM8AF/P6286	LQFP32 (7x7)	64 K			7	1x8-bit: TIM4 3x16-bit: TIM1, TIM2, TIM3 (8/8/8)	LIN(UART), SPI, I ² C	
STM8AF/P62A6	VFQFPN32 (5x5)	128 K						

1. Legend:
 - ADC: Analog-to-digital converter
 - beCAN: Controller area network
 - BOR: Brownout reset
 - I²C: Inter-integrated circuit multimaster interface
 - IWDG: Independent window watchdog
 - LINUART: Local interconnect network universal asynchronous receiver transmitter
 - POR: Power on reset
 - SPI: Serial peripheral interface
 - SWIM: Single wire interface module
 - USART: Universal synchronous asynchronous receiver transmitter
 - Window WDG: Window watchdog

5.5.3 128 kHz low-speed internal RC oscillator (LSI)

The frequency of this clock is 128 kHz and it is independent from the main clock. It drives the independent watchdog or the AWU wakeup timer.

In systems which do not need independent clock sources for the watchdog counters, the 128 kHz signal can be used as the system clock. This configuration has to be enabled by setting an option byte (OPT3/OPT3N, bit LSI_EN).

5.5.4 24 MHz high-speed external crystal oscillator (HSE)

The external high-speed crystal oscillator can be selected to deliver the main clock in normal Run mode. It operates with quartz crystals and ceramic resonators.

- Frequency range: 1 MHz to 24 MHz
- Crystal oscillation mode: preferred fundamental
- I/Os: standard I/O pins multiplexed with OSCIN, OSCOUT

5.5.5 External clock input

An external clock signal can be applied to the OSCIN input pin of the crystal oscillator. The frequency range is 0 to 24 MHz.

5.5.6 Clock security system (CSS)

The clock security system protects against a system stall in case of an external crystal clock failure.

In case of a clock failure an interrupt is generated and the high-speed internal clock (HSI) is automatically selected with a frequency of 2 MHz (16 MHz/8).

Table 4. Peripheral clock gating bits (CLK_PCKENR1)

Control bit	Peripheral
PCKEN17	TIM1
PCKEN16	TIM3
PCKEN15	TIM2
PCKEN14	TIM4
PCKEN13	LINUART
PCKEN12	USART
PCKEN11	SPI
PCKEN10	I ² C

5.8 Analog to digital converter (ADC)

The STM8A products described in this datasheet contain a 10-bit successive approximation ADC with up to 16 multiplexed input channels, depending on the package.

The ADC name differs between the datasheet and the STM8A/S reference manual (see [Table 8](#)).

Table 8. ADC naming

Peripheral name in datasheet	Peripheral name in reference manual (RM0016)
ADC	ADC2

ADC features

- 10-bit resolution
- Single and continuous conversion modes
- Programmable prescaler: f_{MASTER} divided by 2 to 18
- Conversion trigger on timer events, and external events
- Interrupt generation at end of conversion
- Selectable alignment of 10-bit data in 2 x 8 bit result registers
- Shadow registers for data consistency
- ADC input range: $V_{\text{SSA}} \leq V_{\text{IN}} \leq V_{\text{DDA}}$
- Schmitt-trigger on analog inputs can be disabled to reduce power consumption

5.9 Communication interfaces

The following sections give a brief overview of the communication peripheral. Some peripheral names differ between the datasheet and STM8S series and STM8AF series 8-bit microcontrollers reference manual (see [Table 9](#)).

Table 9. Communication peripheral naming correspondence

Peripheral name in datasheet	Peripheral name in reference manual (RM0016)
USART	UART1
LINUART	UART3

5.9.1 Universal synchronous/asynchronous receiver transmitter (USART)

The devices covered by this datasheet contain one USART interface. The USART can operate in standard SCI mode (serial communication interface, asynchronous) or in SPI emulation mode. It is equipped with a 16 bit fractional prescaler. It features LIN master support.

6.2 Alternate function remapping

As shown in the rightmost column of [Table 11](#), some alternate functions can be remapped at different I/O ports by programming one of eight AFR (alternate function remap) option bits. Refer to [Section 9: Option bytes on page 54](#). When the remapping option is active, the default alternate function is no longer available.

To use an alternate function, the corresponding peripheral must be enabled in the peripheral registers.

Alternate function remapping does not effect GPIO capabilities of the I/O ports (see the GPIO section of STM8S series and STM8AF series 8-bit microcontrollers reference manual, RM0016).

7 Memory and register map

7.1 Memory map

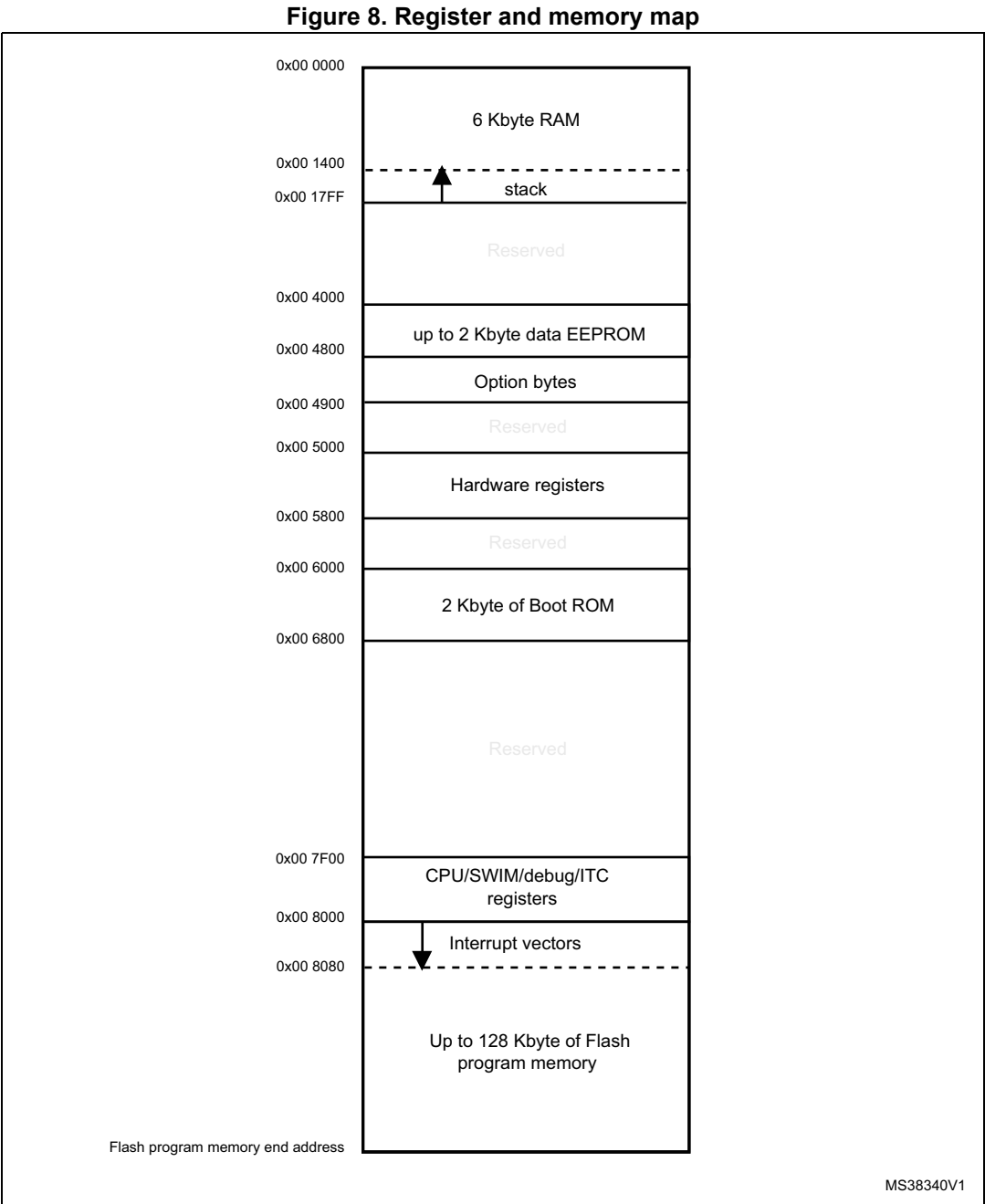


Table 14. General hardware register map

Address	Block	Register label	Register name	Reset status
0x00 505A	Flash	FLASH_CR1	Flash control register 1	0x00
0x00 505B		FLASH_CR2	Flash control register 2	0x00
0x00 505C		FLASH_NCR2	Flash complementary control register 2	0xFF
0x00 505D		FLASH_FPR	Flash protection register	0x00
0x00 505E		FLASH_NFPR	Flash complementary protection register	0xFF
0x00 505F		FLASH_IAPSR	Flash in-application programming status register	0x40
0x00 5060 to 0x005061	Reserved area (2 bytes)			
0x00 5062	Flash	FLASH_PUKR	Flash Program memory unprotection register	0x00
0x00 5063	Reserved area (1 byte)			
0x00 5064	Flash	FLASH_DUKR	Data EEPROM unprotection register	0x00
0x00 5065 to 0x00 509F	Reserved area (59 bytes)			
0x00 50A0	ITC	EXTI_CR1	External interrupt control register 1	0x00
0x00 50A1		EXTI_CR2	External interrupt control register 2	0x00
0x00 50A2 to 0x00 50B2	Reserved area (17 bytes)			
0x00 50B3	RST	RST_SR	Reset status register	0xXX ⁽¹⁾
0x00 50B4 to 0x00 50BF	Reserved area (12 bytes)			
0x00 50C0	CLK	CLK_ICKR	Internal clock control register	0x01
0x00 50C1		CLK_ECKR	External clock control register	0x00
0x00 50C2	Reserved area (1 byte)			

Table 14. General hardware register map (continued)

Address	Block	Register label	Register name	Reset status
0x00 5230	USART	UART1_SR	USART status register	0xC0
0x00 5231		UART1_DR	USART data register	0xFF
0x00 5232		UART1_BRR1	USART baud rate register 1	0x00
0x00 5233		UART1_BRR2	USART baud rate register 2	0x00
0x00 5234		UART1_CR1	USART control register 1	0x00
0x00 5235		UART1_CR2	USART control register 2	0x00
0x00 5236		UART1_CR3	USART control register 3	0x00
0x00 5237		UART1_CR4	USART control register 4	0x00
0x00 5238		UART1_CR5	USART control register 5	0x00
0x00 5239		UART1_GTR	USART guard time register	0x00
0x00 523A		UART1_PSCR	USART prescaler register	0x00
0x00 523B to 0x00 523F	Reserved area (5 bytes)			
0x00 5240	LINUART	UART3_SR	LINUART status register	0xC0
0x00 5241		UART3_DR	LINUART data register	0xFF
0x00 5242		UART3_BRR1	LINUART baud rate register 1	0x00
0x00 5243		UART3_BRR2	LINUART baud rate register 2	0x00
0x00 5244		UART3_CR1	LINUART control register 1	0x00
0x00 5245		UART3_CR2	LINUART control register 2	0x00
0x00 5246		UART3_CR3	LINUART control register 3	0x00
0x00 5247		UART3_CR4	LINUART control register 4	0x00
0x00 5248		Reserved		
0x00 5249		UART3_CR6	LINUART control register 6	0x00
0x00 524A to 0x00 524F	Reserved area (6 bytes)			

Table 14. General hardware register map (continued)

Address	Block	Register label	Register name	Reset status
0x00 5400	ADC	ADC_CSR	ADC control/status register	0x00
0x00 5401		ADC_CR1	ADC configuration register 1	0x00
0x00 5402		ADC_CR2	ADC configuration register 2	0x00
0x00 5403		ADC_CR3	ADC configuration register 3	0x00
0x00 5404		ADC_DRH	ADC data register high	0xXX
0x00 5405		ADC_DRL	ADC data register low	0xXX
0x00 5406		ADC_TDRH	ADC Schmitt trigger disable register high	0x00
0x00 5407		ADC_TDRL	ADC Schmitt trigger disable register low	0x00
0x00 5408 to 0x00 541F	Reserved area (24 bytes)			
0x00 5420	beCAN	CAN_MCR	CAN master control register	0x02
0x00 5421		CAN_MSR	CAN master status register	0x02
0x00 5422		CAN_TSR	CAN transmit status register	0x00
0x00 5423		CAN_TPR	CAN transmit priority register	0x0C
0x00 5424		CAN_RFR	CAN receive FIFO register	0x00
0x00 5425		CAN_IER	CAN interrupt enable register	0x00
0x00 5426		CAN_DGR	CAN diagnosis register	0x0C
0x00 5427		CAN_FPSR	CAN page selection register	0x00
0x00 5428		CAN_P0	CAN paged register 0	0xXX ⁽³⁾
0x00 5429		CAN_P1	CAN paged register 1	0xXX ⁽³⁾
0x00 542A		CAN_P2	CAN paged register 2	0xXX ⁽³⁾
0x00 542B		CAN_P3	CAN paged register 3	0xXX ⁽³⁾
0x00 542C		CAN_P4	CAN paged register 4	0xXX ⁽³⁾
0x00 542D		CAN_P5	CAN paged register 5	0xXX ⁽³⁾
0x00 542E		CAN_P6	CAN paged register 6	0xXX ⁽³⁾
0x00 542F		CAN_P7	CAN paged register 7	0xXX ⁽³⁾
0x00 5430		CAN_P8	CAN paged register 8	0xXX ⁽³⁾
0x00 5431		CAN_P9	CAN paged register 9	0xXX ⁽³⁾
0x00 5432		CAN_PA	CAN paged register A	0xXX ⁽³⁾
0x00 5433		CAN_PB	CAN paged register B	0xXX ⁽³⁾
0x00 5434		CAN_PC	CAN paged register C	0xXX ⁽³⁾
0x00 5435		CAN_PD	CAN paged register D	0xXX ⁽³⁾
0x00 5436		CAN_PE	CAN paged register E	0xXX ⁽³⁾

Table 14. General hardware register map (continued)

Address	Block	Register label	Register name	Reset status
0x00 5437	beCAN	CAN_PF	CAN paged register F	0xXX ⁽³⁾
0x00 5438 to 0x00 57FF	Reserved area (968 bytes)			

1. Depends on the previous reset source.
2. Write only register.
3. If the bootloader is enabled, it is initialized to 0x00.

Table 15. CPU/SWIM/debug module/interrupt controller registers

Address	Block	Register label	Register name	Reset status
0x00 7F00	CPU ⁽¹⁾	A	Accumulator	0x00
0x00 7F01		PCE	Program counter extended	0x00
0x00 7F02		PCH	Program counter high	0x80
0x00 7F03		PCL	Program counter low	0x00
0x00 7F04		XH	X index register high	0x00
0x00 7F05		XL	X index register low	0x00
0x00 7F06		YH	Y index register high	0x00
0x00 7F07		YL	Y index register low	0x00
0x00 7F08		SPH	Stack pointer high	0x17 ⁽²⁾
0x00 7F09		SPL	Stack pointer low	0xFF
0x00 7F0A		CC	Condition code register	0x28
0x00 7F0B to 0x00 7F5F	Reserved area (85 bytes)			
0x00 7F60	CPU	CFG_GCR	Global configuration register	0x00
0x00 7F70	ITC	ITC_SPR1	Interrupt software priority register 1	0xFF
0x00 7F71		ITC_SPR2	Interrupt software priority register 2	0xFF
0x00 7F72		ITC_SPR3	Interrupt software priority register 3	0xFF
0x00 7F73		ITC_SPR4	Interrupt software priority register 4	0xFF
0x00 7F74		ITC_SPR5	Interrupt software priority register 5	0xFF
0x00 7F75		ITC_SPR6	Interrupt software priority register 6	0xFF
0x00 7F76		ITC_SPR7	Interrupt software priority register 7	0xFF
0x00 7F77		ITC_SPR8	Interrupt software priority register 8	0xFF
0x00 7F78 to 0x00 7F79	Reserved area (2 bytes)			
0x00 7F80	SWIM	SWIM_CSR	SWIM control status register	0x00

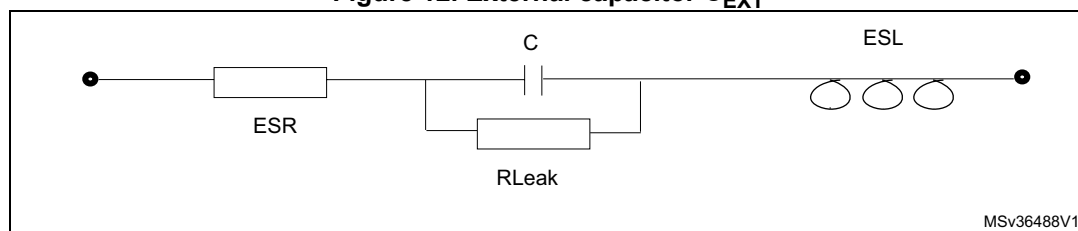
Table 25. Operating conditions at power-up/power-down

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
t_{VDD}	V_{DD} rise time rate	-	2 ⁽¹⁾	-	∞	$\mu\text{s/V}$
	V_{DD} fall time rate	-	2 ⁽¹⁾	-	∞	
t_{TEMP}	Reset release delay	V_{DD} rising	-	1	1.7	ms
	Reset generation delay	V_{DD} falling	-	3	-	μs
V_{IT+}	Power-on reset threshold ⁽²⁾ (3)	-	2.65	2.8	2.95	V
V_{IT-}	Brown-out reset threshold	-	2.58	2.73	2.88	
$V_{HYS(BOR)}$	Brown-out reset hysteresis	-	-	70 ⁽¹⁾	-	mV

1. Guaranteed by design, not tested in production.
2. If V_{DD} is below 3 V, the code execution is guaranteed above the V_{IT-} and V_{IT+} thresholds. RAM content is kept. The EEPROM programming sequence must not be initiated.
3. There is inrush current into V_{DD} present after device power on to charge C_{EXT} capacitor. This inrush energy depends from C_{EXT} capacitor value. For example, a C_{EXT} of 1 μF requires $Q=1 \mu\text{F} \times 1.8 \text{ V} = 1.8 \mu\text{C}$.

10.3.1 VCAP external capacitor

Stabilization for the main regulator is achieved connecting an external capacitor C_{EXT} to the V_{CAP} pin. C_{EXT} is specified in [Table 24](#). Care should be taken to limit the series inductance to less than 15 nH.

Figure 12. External capacitor C_{EXT} 

1. Legend: ESR is the equivalent series resistance and ESL is the equivalent inductance.

10.3.2 Supply current characteristics

The current consumption is measured as described in [Figure 9 on page 59](#) and [Figure 10 on page 60](#).

If not explicitly stated, general conditions of temperature and voltage apply.

Low-speed internal RC oscillator (LSI)

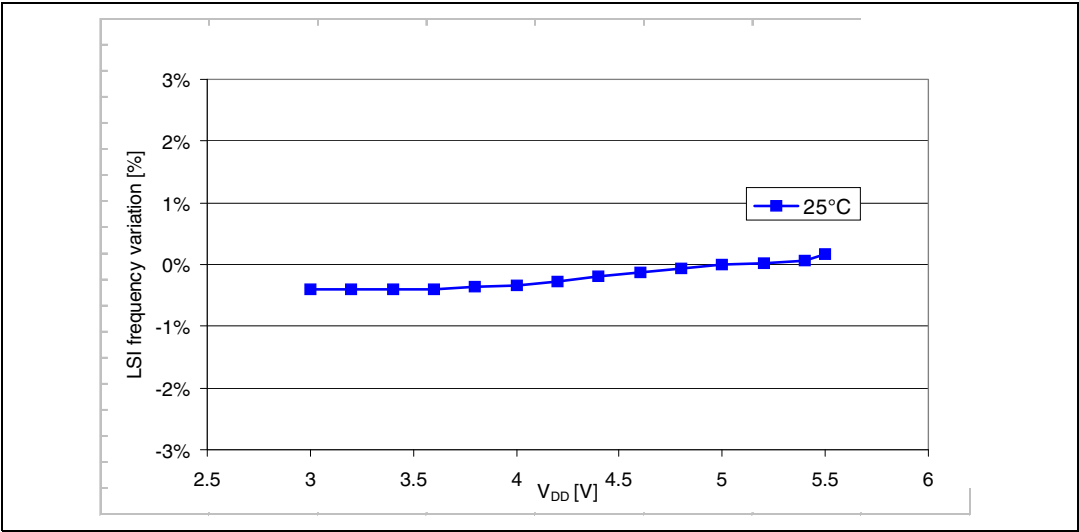
Subject to general operating conditions for V_{DD} and T_A .

Table 34. LSI oscillator characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
f_{LSI}	Frequency	-	112	128	144	kHz
$t_{su(LSI)}$	LSI oscillator wakeup time	-	-	-	7 ⁽¹⁾	μs

1. Guaranteed by characterization results, not tested in production.

Figure 22. Typical LSI frequency vs V_{DD}



10.3.9 SPI interface

Unless otherwise specified, the parameters given in [Table 41](#) are derived from tests performed under ambient temperature, f_{MASTER} frequency, and V_{DD} supply voltage conditions. $t_{\text{MASTER}} = 1/f_{\text{MASTER}}$.

Refer to I/O port characteristics for more details on the input/output alternate function characteristics (NSS, SCK, MOSI, MISO).

Table 41. SPI characteristics

Symbol	Parameter	Conditions		Min	Max	Unit
f_{SCK} $1/t_{\text{c(SCK)}}$	SPI clock frequency	Master mode		0	10	MHz
		Slave mode	$V_{\text{DD}} < 4.5 \text{ V}$	0	6 ⁽¹⁾	
			$V_{\text{DD}} = 4.5 \text{ V to } 5.5 \text{ V}$	0	8 ⁽¹⁾	
$t_{\text{r(SCK)}}$ $t_{\text{f(SCK)}}$	SPI clock rise and fall time	Capacitive load: $C = 30 \text{ pF}$		-	25 ⁽²⁾	ns
$t_{\text{su(NSS)}}^{(3)}$	NSS setup time	Slave mode		$4 * t_{\text{MASTER}}$	-	
$t_{\text{h(NSS)}}^{(3)}$	NSS hold time	Slave mode		70	-	
$t_{\text{w(SCKH)}}^{(3)}$ $t_{\text{w(SCKL)}}^{(3)}$	SCK high and low time	Master mode	$t_{\text{SCK}}/2 - 15$	$t_{\text{SCK}}/2 + 15$	$t_{\text{w(SCKH)}}^{(3)}$ $t_{\text{w(SCKL)}}^{(3)}$	
$t_{\text{su(MI)}}^{(3)}$ $t_{\text{su(SI)}}^{(3)}$	Data input setup time	Master mode		5	-	
		Slave mode		5	-	
$t_{\text{h(MI)}}^{(3)}$ $t_{\text{h(SI)}}^{(3)}$	Data input hold time	Master mode		7	-	
		Slave mode		10	-	
$t_{\text{a(SO)}}^{(3)(4)}$	Data output access time	Slave mode		-	$3 * t_{\text{MASTER}}$	
$t_{\text{dis(SO)}}^{(3)(5)}$	Data output disable time	Slave mode		25		
$t_{\text{v(SO)}}^{(3)}$	Data output valid time	Slave mode (after enable edge)	$V_{\text{DD}} < 4.5 \text{ V}$	-	75	
			$V_{\text{DD}} = 4.5 \text{ V to } 5.5 \text{ V}$	-	53	
$t_{\text{v(MO)}}^{(3)}$	Data output valid time	Master mode (after enable edge)		-	30	
$t_{\text{h(SO)}}^{(3)}$	Data output hold time	Slave mode (after enable edge)		31	-	
$t_{\text{h(MO)}}^{(3)}$		Master mode (after enable edge)		12	-	

1. $f_{\text{SCK}} < f_{\text{MASTER}}/2$.

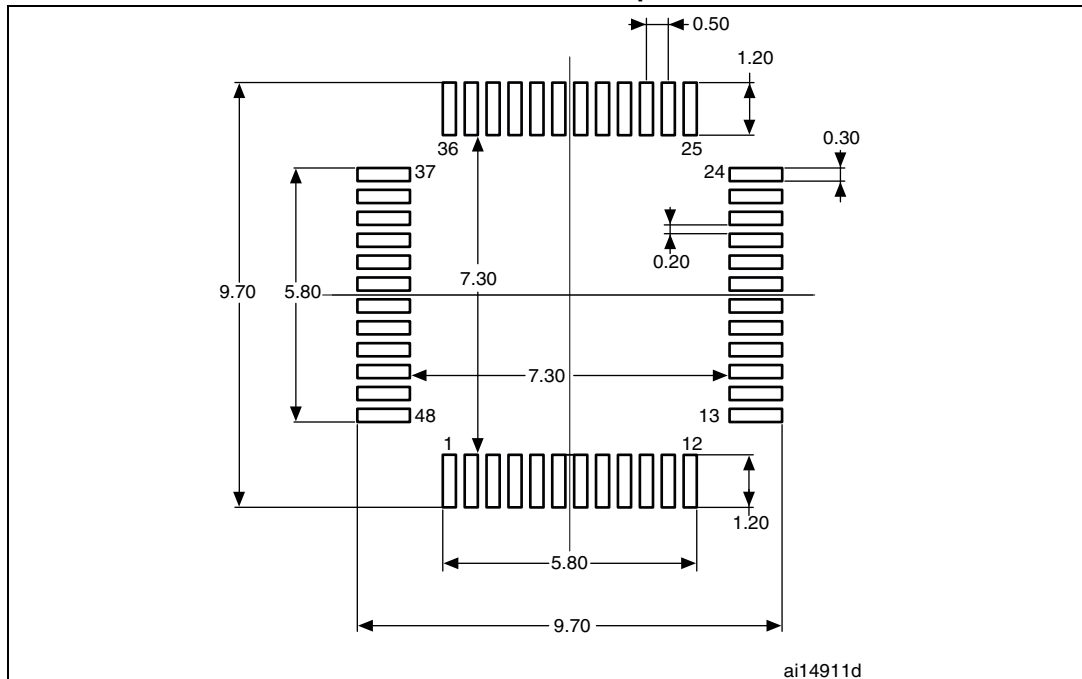
2. The pad has to be configured accordingly (fast mode).

3. Guaranteed by design or by characterization results, not tested in production.

4. Min time is for the minimum time to drive the output and the max time is for the maximum time to validate the data.

5. Min time is for the minimum time to invalidate the output and the max time is for the maximum time to put the data in Hi-Z.

Figure 52. LQFP48 - 48-pin, 7 x 7 mm low-profile quad flat package recommended footprint



1. Dimensions are expressed in millimeters.

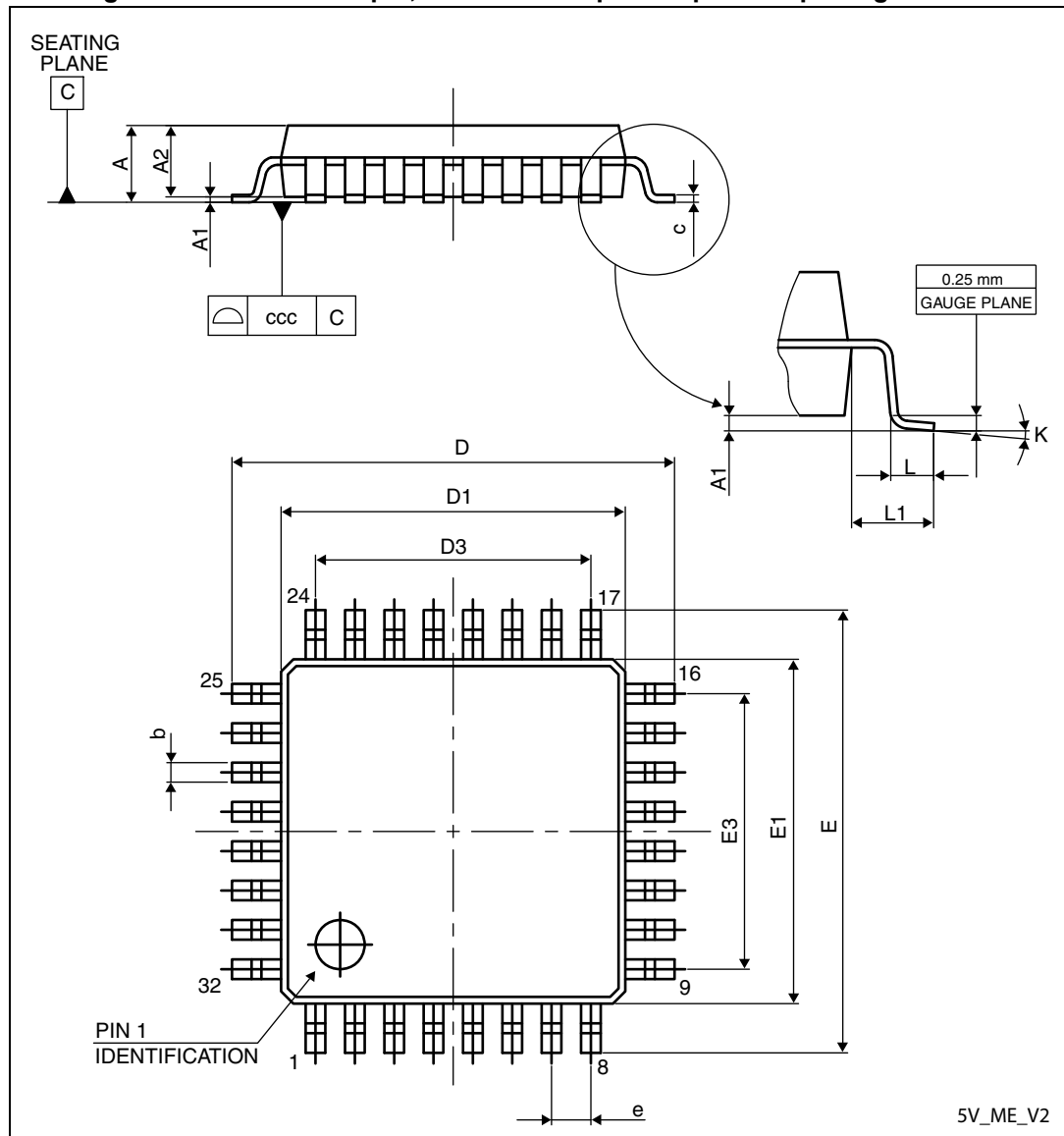
Device marking

The following figure gives an example of topside marking orientation versus pin 1 identifier location.

Other optional marking or inset/upset marks, which identify the parts throughout supply chain operations, are not indicated below.

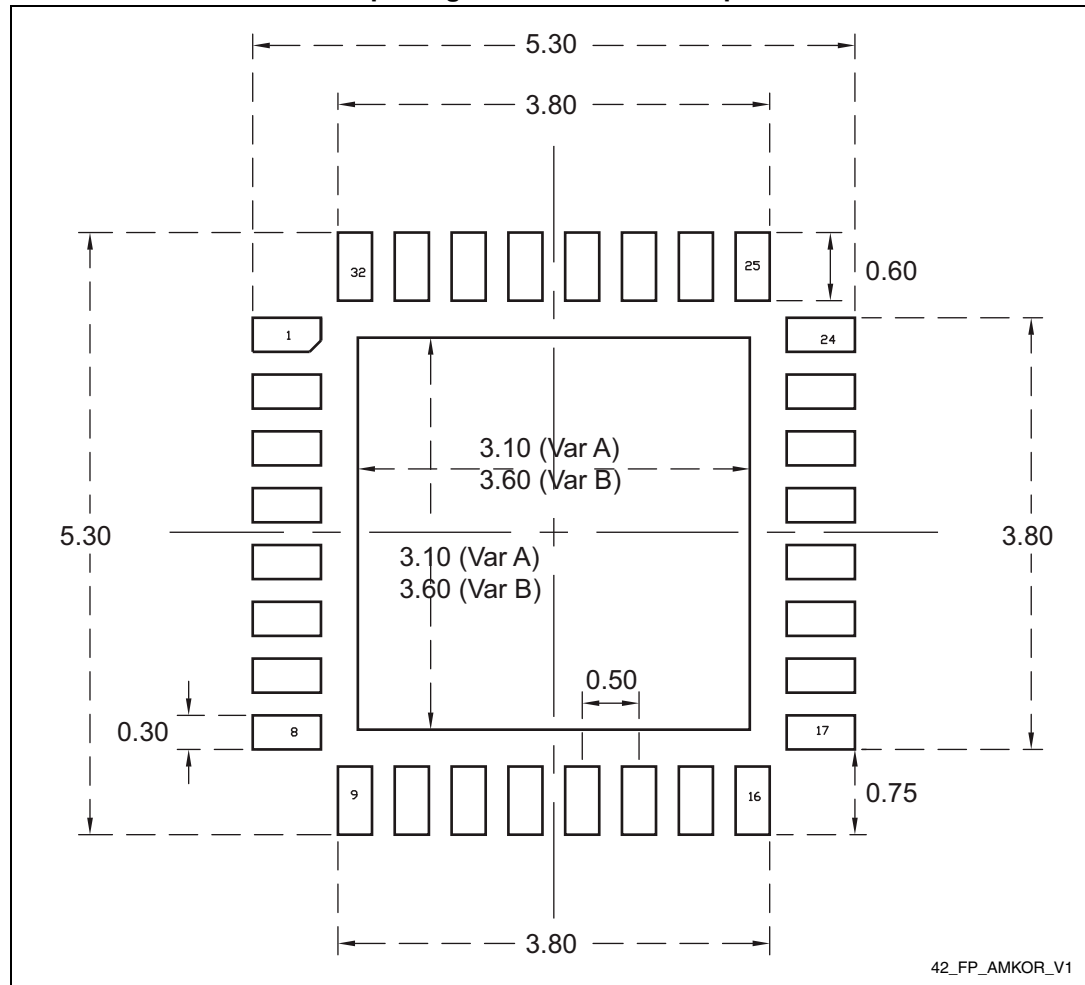
11.4 LQFP32 package information

Figure 54. LQFP32 - 32-pin, 7 x 7 mm low-profile quad flat package outline



1. Drawing is not to scale.

Figure 58. VFQFPN32 - 32-pin, 5 x 5 mm, 0.5 mm pitch very thin profile fine pitch quad flat package recommended footprint



1. Dimensions are expressed in millimeters.

13.3 Programming tools

During the development cycle, STice provides in-circuit programming of the STM8A Flash microcontroller on the application board via the SWIM protocol. Additional tools are to include a low-cost in-circuit programmer as well as ST socket boards, which provide dedicated programming platforms with sockets for programming the STM8A.

For production environments, programmers will include a complete range of gang and automated programming solutions from third-party tool developers already supplying programmers for the STM8 family.

Table 55. Document revision history (continued)

Date	Revision	Changes
13-Apr-2010	6	Updated title on cover page. Modified cover page header to clarify the part numbers covered by the datasheets. Updated footnote on Table 1: Device summary to add 'P' order codes. Changed definition of 'P' order codes. 'Q' order codes (FASTROM and EEPROM) removed. Reorganized the content of Section 5: Product overview. Table 11: STM8AF526x/8x/Ax and STM8AF6269/8x/Ax pin description updated PD7/TLI alternate function, removed caution note for PD6/ LINUART_RX, and added note to PA1/OSCIN. Renamed Section 7: Memory and register map, and merged content with Section: Register map. Updated Figure 8: Register and memory map. Renamed BL_EN and NBL_EN, BL and NBL, respectively, in Table 18: Option bytes. Updated AFR4 definition in Table 19: Option byte description. Added C_{EXT} in Table 24: General operating conditions, and Section 10.3.1: VCAP external capacitor. Updated t_{VDD} in Table 25: Operating conditions at power-up/power-down. Moved Table 30: Typical peripheral current consumption VDD = 5.0 V to Section : Current consumption for on-chip peripherals. Removed V_{ESD(MM)} from Table 47: ESD absolute maximum ratings. Updated Section 12: Ordering information to the devices supported by the datasheet. Updated Section 13: STM8 development tools.
08-Jul-2010	7	Added STM8AF5168 and STM8AF518A part number in Figure 4, and STM8AF618A in Figure 5. Added STM8AF52xx, STM8AF6269, STM8AF628x, and STM8AF62Ax. Updated D temperature range to -40 to 150°C. Updated number of I/Os on cover page. Added Table 23: Operating lifetime. Restored V_{ESD(MM)} from Table 47: ESD absolute maximum ratings. Table 24: General operating conditions: updated V_{CAP} information. ESL parameter, and range D maximum junction temperature (T_J). Added STM8AF52xx and STM8AF62xx, and footnote in Section 12: Ordering information. Updated Section 13: STM8 development tools: added Table: Product evolution summary, and split the beCAN time triggered communication mode limitation in two sections.

Table 55. Document revision history (continued)

Date	Revision	Changes
31-Mar-2014	10 (continued)	Added: – Figure 7: STM8AF52x6 VFQFPN32 32-pin pinout; – the caution in Section 5.10: Input/output specifications, – The table footnote “Not recommended for new designs” to Table: STM8AF/H/P51xx product line-up with CAN and Table: STM8AF/H/P61xx product line-up without CAN. – The figure footnotes to Figure 7: STM8AF52x6 VFQFPN32 32-pin pinout and Figure: VFQFPN 32-lead very thin fine pitch quad flat no-lead package (5 x 5)
13-Jun-2014	11	Added STM8AF52A6 part number.
09-Jun-2015	12	Added: – the third table footnote to Table 25: Operating conditions at power-up/power-down, – Figure 47: LQFP80 marking example (package top view), – Figure 50: LQFP64 marking example (package top view), – Figure 53: LQFP48 marking example (package top view), – Figure 56: LQFP32 marking example (package top view), – Figure 59: VFQFPN32 marking example (package top view), – the footnote about the device marking to Figure 60: STM8AF526x/8x/Ax and STM8AF6269/8x/Ax ordering information scheme1. Removed STM8AF51xx and STM8AF61xx obsolete root part numbers, and consequently “H” products: – Table 1: Device summary, – Section 1: Introduction, – Section 2: Description, – Section 3: Product line-up, – Table 12: Memory model 128K, – Section 10.3: Operating conditions, – Figure 60: STM8AF526x/8x/Ax and STM8AF6269/8x/Ax ordering information scheme1. Moved Section 11.6: Thermal characteristics to Section 11: Package information. Updated: – the product naming in the document headers and captions, – the standard reference for EMI characteristics in Table 46: EMI data.
13-Jun-2016	13	Updated Table 53: VFQFPN32 - 32-pin, 5 x 5 mm, 0.5 mm pitch very thin profile fine pitch quad flat package mechanical data